

# Digital Controller **COMPACT CONTROLLER M [CC-M]** (PROGRAMMABLE CONTINUOUS OUTPUT TYPE)

DATA SHEET

PDA2

The Compact Controller M (programmable continuous output type) is a multi-loop process controller.

It accepts 1 to 5 V DC and signals from thermocouples and resistance bulb as input, and is provided with abundant control and computation functions to allow configuring a flexible system with a high cost performance.

## FEATURES

### 1. Multi-loop controller of up to 4 control outputs.

CC-M has max.4 control outputs, that is real 4-loop multi-loop controller.

[Note] In this data sheet, the term "loop" is used in the same meaning as the quantity of control output.

### 2. Control and computation functions dependent on wafers

Control and computation functions are implemented by combining function-software packages called "WAFERS." Since the WAFERS are built in the controller, optimum system can be programmed by using the front-panel keys and the PC based configurator.

### 3. High visibility ensured with color graphic display

A color LCD is adopted for graphic display of multi-loop bar graph and trend screens, etc.

### 4. Communication function (option)

Fuji PLC link (T-link) are available.

### 5. Back-up (option)

If the controller becomes faulty, influence over the system can be evaded by changing the built-in backup operation unit.

### 6. Memory card (option)

Memory card can save any data, for example process input, WAFER output, etc.



## SPECIFICATIONS

### 1. Control and Computation Functions

Control and computation functions are implemented by combining function-software packages called "WAFERS." Combination of WAFERS is called "WAFER connection." CC-M comprises 100 kinds of WAFERS.

WAFER connection is made by operating the keys on the front panel or using the PC based configurator.

#### (1) PID control

- Number of loops and PID
  - : Selectable among the following
  - 1 loop (1 control output / 2PID)
  - 2 loops (2 control outputs / 4PID)
  - 4 loops (4 control outputs / 8PID)
- Proportional band (P)
  - : 1.0 to 3276.7%, set at 3000.0% for delivery
- Integration time (I)
  - : 0.1 to 3276.7 s, set at 3000.0 s for delivery
- Derivative time (D)
  - : 0.0 to 900.0 s, set at 0.0 s for delivery

#### (2) Programming function

- Programming method
  - : WAFER connection
- Program capacity
  - : 48 WAFERS x 4 loops (max. 192 WAFERS)
  - A maximum of 48 WAFERS usable in 1 loop
- Kind of wafer : 100 kinds listed in Table 1

**(3) Computation cycle**

: 200 ms for 4-loop (8PID) control of simplicity PID

**(4) Alarm function**

- **Method** : Alarm can be displayed and output through WAFER connection.
- **Kinds** : Each high/low of PV, SV and MV, PV change rate alarm, MV change rate alarm, high/low deviations.

**2. Input Signals**

Performance under reference condition (23±2°C, 55±10%RH, 100 V to 240 V AC, 50/60Hz power supply frequency or 24 V DC power supply voltage, free from vibration and the effect of external noise)

**2-1 Analog input signal****• Number of inputs**

Screw terminal ; 7 inputs  
Compression terminal ; 8 inputs

**• Inpute signal types :**

DC voltage, DC current, thermocouple (option), resistance bulb (option)  
Two thermocouple inputs or two resistance bulb inputs are selectable.

**(1) DC voltage / DC current**

- Input range: Selectable among 0 to 5 V DC, 1 to 5 V DC and 0 to 10 V DC  
Initial set before delivery : 1 to 5 V DC
- Input accuracy: ±0.1% of input span±1 digit
- Scaling (Engineering data conversion) :  
Settable within a range from -32767 to 32767  
4, 3, 2, 1 or 0 digit below decimal point is selectable.  
Initial set before delivery : 0.00% to 100.00%
- Engineering unit: Settable in up to 8 characters  
Usable characters: Alphabets numerals, symbols such as +, -, \*, etc.
- Input accuracy guarantee range: -5% to 105% of input range. However, minus inputs are excluded.
- Maximum continuous permissible voltage: ±35 V
- Input resistance: 1 MΩ or more
- Influence by ambient temperature: ±0.1% FS/10°C or less.
- Influence by power supply fluctuation: ±0.1% FS or less.
- Isolation : Non-isolated from internal circuit.
- In case of current input:  
Shunt resistor need to be connected to the analog input terminal.  
(250 Ω shunt resistor is optional item)

**(2) Thermocouple (option)**

- Types and measurable ranges:  
\* See Table 2.
- Input accuracy: ±0.2% FS ±1 digit  
[Note]B type: ±5% between 0 to 400°C  
S and R type: ±1% between 0 to 500°C  
All type of TC: ±5% under -100°C

- Reference junction compensation error: ±1.0°C (provided measurable range is -50°C and higher)  
[Note]Reference junction compensation resistor is connected at external input terminal in case of thermocouple input is ordered.
- Input accuracy guarantee range: -5% to 105% of input range.
- Input resistance: 1 MΩ or more
- Allowable signal source resistance: 100 Ω or less (Zener barrier connection unallowable)
- Influence by signal source resistance: About 0.25 μV/Ω
- Influence by ambient temperature: ±0.2% FS/10°C ±1°C or less.
- Influence by power supply fluctuation: ±0.2% FS ±1°C or less
- Burnout detection: Provided
- Isolation: Isolated from internal circuit.

**(3) Resistance bulb (option)**

- Types and measurable ranges:  
\* See Table 2.
- Input accuracy: ±0.2% FS ±1 digit
- Input accuracy guarantee range: -5% to 105% of input range
- Allowable wiring resistance: 10Ω or less per wire, provided wiring resistance must be equal among 3 wires (Zener barrier connection unallowable)
- Influence by ambient temperature: ±0.2% FS/10°C or less.
- Influence by power supply fluctuation: ±0.2% FS or less
- Burnout detection: Provided
- Isolation: Isolated from internal circuit.

[Note] FS: full span.

**• Sampling period**

: 100 ms

**2-2 Digital input signal****• Number of inputs**

: 10 inputs

**• Electrical specifications**

: No-voltage contact or transistor contact  
ON/0 V, OFF/24 V, ON current/about 8 mA  
Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.

**• Contact rating : 30 V DC, 10 mA or more****• Signal judgment**

: No-voltage contact  
Contact resistance;  
200 Ω or less at ON,  
100 kΩ or more at OFF  
: Transistor contact  
1 V max at ON.,  
leakage current 100 μA max. at OFF

### 3. Output Signals

Performance under reference condition (23±2°C, 55±10%RH, 100 V to 240 V AC, 50/60 Hz power supply frequency or 24 V DC power supply voltage, free from vibration and the effect of external noise)

#### 3-1 Analog output signal

##### (1) Control output

- **Number of outputs**
    - : Selectable among 1, 2 and 4 outputs
  - **Output signal** : 4 to 20 mA DC
  - **Output accuracy**
    - : ±0.2% FS
  - **Load resistance**
    - : 600 Ω or less
  - **Output accuracy guarantee range**
    - : 2 to 22 mA DC
  - **Influence by ambient temperature**
    - : ±0.2% FS/10°C or less
  - **Influence by power supply fluctuation**
    - : ±0.2% FS or less
  - **Isolation** : Non-isolated from internal circuit
- ##### (2) Auxiliary analog output
- **Number of outputs:**
    - Screw terminal ; 5 outputs
    - Compression terminal ; 4 outputs
  - **Types of signal** : Selectable among 0 to 5 V DC, 1 to 5 V DC and 0 to 10 V DC  
Initial set before delivery: 1 to 5 V DC
  - **Output accuracy**
    - : ±0.1% FS
  - **Load resistance**
    - : 15 kΩ or more
  - **Output guarantee range**
    - : 1 to 5 VDC : -12.5% to 112.5%
    - : 0 to 5 VDC : 0% to 112.5%
    - : 0 to 10VDC : 0% to 105%
  - **Influence by power supply fluctuation**
    - : ±0.1% FS or less
  - **Isolation** : Non-isolated from internal circuit

#### 3-2 Digital output signal

- **Number of outputs**
  - : 10 outputs
- **Electrical specifications**
  - : Transistor open collector
  - 1 V max. at ON, 10 μA max at OFF.
  - Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.
- **Output rating** : 30 V DC, 100 mA max. (resistive load)

#### 3-3 Fault output signal (terminal symbol FLT)

- **Number of outputs**
  - : 1 output
- **Electrical specifications**
  - : Transistor open collector
  - 1 V max. at ON, 10 μA max at OFF.
  - Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.
- **Output rating** : 30 V DC, 100 mA max. (resistive load)

### 4. Display

- **Display unit** : 16 Colors graphic liquid crystal display, with CFL back light and contrast adjust function.
- **Contents of display**
  - : Menu
  - : Loop panel (1, 2, 4 and 8 loops)
  - Bar graph display, digital display, etc.
  - [Note] The term "loop" hereby indicates the number of control blocks. It does not mean the number of control outputs.
  - : Tuning screen
  - : Trend screen (max. 8 screens)
  - : Alarm and alarm historical screen
  - : Analog input/output and digital input/output indication screen
  - : WAFER connection screen
  - : Parameter setting screen

### 5. Setting and Operation

#### (1) Set point setting method

- **Setting key** : Up key/down key
- **Setting speed** : About 40 s/FS
- **Setting resolution**
  - : 0.05% FS/each key press

#### (2) Control output operation method

- **Operation key** : Up key, down key and high-speed key
- **Operation speed**
  - : About 40 s/FS (usual),
  - about 8 s/FS (high speed)

#### (3) Operation mode

- **Kinds of operation mode**
  - : C (or R), A, M and HM
- [Note] C : Cascade mode (operation according to remote set point)
- R : Remote mode (operation according to remote set point)
- A : Auto mode (operation according to the local set point)
- M : Manual mode (control output to be manually operated by operator)
- HM : Hard manual mode (the mode in which operation is performed with a backup operating device)

[Remark] C and R have different nameplates, while operation is the same.

#### • **Setting method**

- : Selectable from the followings by specifying the code symbols.
- C - A - M
- A - M
- R - A - M

- **Changeover** : Balance bumpless changeover from Auto to Remote and from Auto to Cascade
- Balanceless bumpless in other changeover

[Note] Balance bumpless changeover is a method where each setting value needs to be balanced by operator himself at the time of changeover.

Balanceless bumpless changeover is a method where each setting value is automatically balanced by the controller at the time of changeover.

**(4) Security**

- **Method** : Setting of a password
- **Password** : Settable in 4 numerals (within 0000 to ffff)  
Initial set before delivery: 0000

- **Contents of security**  
: Inhibition of parameter setting

**(5) Other setting items**

- **Tag name** : Settable in up to 8 characters  
Usable characters; alphabets, numerals, symbols such as +, -, \*, etc.

**6. Power Supply**

- **Voltage rating** : 100 V to 240 V AC 50/60 Hz/24 V DC  
[According to Code Symbols]
- **Allowable range**  
: 85 V to 264 V AC/20 V to 30 V DC [According to Code Symbols]
- **Frequency** : 47 to 63 Hz
- **Power consumption**  
: 60 VA or less (100 V to 240 V AC)  
: 30 W or less (24 V DC)
- **Power supply output voltage (terminal symbol VP and PC)**  
: 20 V to 30 V DC, max. 40 mA

**7. General performance and characteristics**

- **Insulation resistance**  
: 500 V DC, 50 MΩ or more.
- **Dielectric strength**  
: 2,000 V AC for 1 minute between power terminal and ground terminal in case of 100 V to 240 V AC power supply  
: 500 V AC for 1 minute between power terminal and ground terminal in case of 24 V DC power supply.  
: 500 V AC for 1 minute between signal, communication terminals and ground terminal
- **Rush current** : 60 A or less. (100 V AC to 240 V AC power supply)
- **Clock** : Set and display year, month, day, hour, minute, second  
accuracy : ±100 ppm except of time lag shorter than 1 s / power ON / OFF action.
- **Memory backup**  
: Protection by lithium battery.  
(expected battery life is about 2 years under room temperature)  
Parameter and program are stored non-volatile memory.

**8. Operating and storage conditions**

- **Location** : Indoor
- **Operating temperature**  
: 0 to 50°C  
: 0 to 40°C in case of multiple mounting  
( **Temperature change rate**  
: Max. 10°C / h)
- **Transport and storage temperature**  
: -20 to 70°C  
( **Temperature change rate**  
: Max. 20°C / h)
- **Operating humidity**  
: 5 to 90% RH, condensation unallowable

- **Transport and storage humidity**  
: 5 to 95% RH, condensation unallowable
- **Operating continuous vibration**  
: 4.9 m/s<sup>2</sup> or less
- **Transport and storage shock**  
: Fall of 60cm max. in packed status

**9. Power Failure and restart Function**

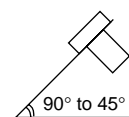
- **Permissible duration of momentary power failure**  
: 20 ms at 90 V AC (100 V to 240 V AC only)  
In the case of 24V DC, it is recommended to avoid power failure problem that system power supply unit with permissible duration of momentary power failure of 20 ms or more (PXJ, for example) is used.
- **Behavior at power failure detection**  
: Control stops at detection of power failure.
- **Power recovery mode**  
: Selectable initial start and continuous start

**10. Self-Diagnosis**

- **Control and computation circuit failure**  
: Monitoring with watchdog timer
- **Input signal failure**  
: Voltage/current input  
Monitoring of range over  
: Thermocouple and resistance bulb  
Monitoring of disconnection
- **Control output signal failure**  
: Monitoring of disconnection by read back check
- **Behavior at failure**  
: FLT is indicated, FLT lamp lights, FLT output signal turns on, control stops and control output is held.

**11. Structure**

- **Enclosure** : Plastic (material: PC-ABS)
- **Finish color** : Front frame and enclosure both gray
- **Flame resistance**  
: UL94V-0
- **Protection** : Front face; IP54 (display unit and operation key)
- **External dimensions (W x H x D)**  
Screw terminal type : 72 x 144 x 272 mm  
Compression terminal type : 72 x 144 x 280 mm
- **Mass** : 1.9 kg or less
- **Mounting method**  
: Flush on indoor panel  
Vertical mounting as standard  
Tilted mounting allowed within backward angle 0° to 45°.



For panel cutout dimension, refer to Panel Cutout Dimensions

- **External terminal**  
: Screw terminal type (M3.5) or Compression terminal type (by the code symbols)

## 12. Backup Function (option)

- **Method** : With backup operation unit
- **Number of control outputs** : 1, 2 or 4 outputs selectable.
- **Output signal** : 4 to 20 mA DC
- **Indication** : Control output indication of each loop (mA indication)
- **Indicator** : 21-segment LED
- **Indication changeover** : Changeable to each loop by loop selection key  
Loop No. indicated by 1-digit LED
- **Operation key** : Control output up, control output down, loop selection
- **Operation resolution** : 5%
- **Backup changeover** : Changeover has been made by the HM (Hard Manual) switch. However, changeover cannot be made when the backup operation unit is faulty.  
: In all loops, changeover to the HM mode is blanceless and bumpless.

## 13. Communications (option)

### 13-1 T-link interface (option)

- **Communication behavior** : Master or slave
- **Master communication** : Connecting to CPU capsule  
: I/O transmission ; 4 / 8 / 16-word inputs and / or outputs  
: Message transmission ; Single element
- **Slave communication** : Connecting to I/O equipments  
Connectable equipments ; FTLS, PNA, PYH  
: I/O transmission only  
Input / output area is 100 words (Message transmission, transmisson between master stations, loader transmission and duplex transmission are not available.)
- **Common items for both master communication and slave communication** : Wiring system ; multi-drop  
: Communication speed ; 500 kbps  
: Communication distance; Max. 500 m in total (for master), max. 50 m in total (for slave)  
: Isolation ; Not isolated from internal circuit  
: Terminator ; 100 Ω (optional item)

### 13-2 Loader interface

- **Communication protocol** : Based on Modbus® protocol
- **Physical specification** : RS232C
- **Communication distance** : Max. 3 m

## 14. Memory Card Interface (option)

- **Specification** : Compact Flash® (Based on CFA)
- **Compatible memory card** : 5 V flash memory card  
Capacity 4, 20 and 32 MB
- **Application** : Process data logging (32 points or less)
- **Saving period** : 1 s min.
- **Data storage capacity**

Memory card capacity	Data storage
4MB	about 180 thousand data
20MB	about 900 thousand data
32MB	about 1.35 million data

[Remark] Values of 4 points are recorded simultaneously by one data.

[Note] The data of max. 16 points (4 screens) can be stored at storage time as 1 s.

- **Format method** : Dependent on this controller
- **Data readout** : Readout by PC using PCMCIA card slot
- **Recommended memory card** : Made by Sandisk corporation  
Sandisk compact Flash memory card is standardized and on the market.  
Models ; SDCFB-4-101-00 (4MB)  
SDCFB-20-101-00 (20MB)  
SDCFB-32-101-00 (32MB)

## 15. Standards under Conformity

### (1) General safety

- : IEC 1010-1 (1990)
- EN 61010-1 (1993)

### (2) EMC

- : Emission EN 50081-2 (1994)
- Immunity EN 50082-2 (1995)

## 16. Configuration Software

### 16-1 Programming loader software

- This software is installed on the CD-ROM form instruction manual (PDZQ1001) supplied with the main unit.  
Communication cable (PDZL1001) is optionally available.
- WAFER connection can be entered, edited, uploaded and downloaded.
- Operation parameter can be entered, edited, uploaded and downloaded.

### 16-2 Recommended personal computer system

- **Hardware** : DOS/V machine, Pentium™ 100 MHz or higher  
Free hard disk capacity 40 MB or more, memory capacity 32 MB or more
- **Operating system** : Microsoft® Windows® 98 SE/2000/XP  
Japanese

**Table 1**  
**List of WAFERS**

WAFER name	Kinds	Outline
Primary PID	9	Carries out computation on the primary loop.
Secondary PID	5	Carries out computation on the secondary loop.
Gain schedule	2	Outputs the PID parameter corresponding to input 1 according to the gain schedule table.
Bit concatenate	8	Outputs digital data as word data to an external expansion I/O.
Bit slicing	1	Slices the digital data acquired as word data from an external expansion I/O into each bit.
Encoder	1	Encodes an input signal into a binary code.
Sawtooth wave generator	1	Generates a sawtooth wave with a slope entered for each cycle time.
BCD	5	Converts BCD data into binary data and binary data into BCD data.
Logical operation	6	Carries out AND, OR, NOT, XOR and a combination of these logical operations.
Arithmetic operation	8	Carries out a combination of addition, subtraction, multiplication and division.
Temperature/pressure compensation	1	Carries out temperature and pressure compensation through use of differential pressure, compensated pressure, proper temperature.
Linearize	7	Carries out segmented-line approximation with 15-segmented-line function.
Program control	4	Time schedule control by step or polygonal line approximation with 7 segments.
Flip-flop	1	RS flip-flop.
Pulse width integration	1	Adds the change of input at each basic cycle to the previous integration value.
Selector	1	Compares two input values, and provides High output(Large one), Low output(Small one), and result of judgement on large/small.
Changeover	1	Selects input or output via a switch function. Analog hold circuit also provided.
Timer	1	Outputs on-delay, off-delay timer signal via start of input signal according to timer setting.
Absolute value/sign inversion	1	Carries out absolute value processing on input and outputs the result. Also judges the sign(Positive, negative) of input value and outputs the result.
Square root extraction	1	Extracts square root of input value and outputs the result. Low input cutoff function equipped.
Lead, lag	3	Carries out lead/lag operation on the input and outputs the results. Used as analog filter function and for various compensations.
Limiter	1	Limits the input within the range of high/low limit settings, and outputs the result. Also outputs high/low limit alarm signal.
Ramp function	2	Outputs signal which changes...in ramp from toward target value at the set full scale time. There are two of these wafers...in minute unit and hour unit.
Analog averaging	1	Carries out sequential integration on input data, calculates the average value at each averaging time, and outputs the result.
Analog integration	1	Integrates the value obtained by multiplying the input data by a proportional constant, and outputs the result.

WAFER name	Kinds	Outline
Pulse generation	1	Outputs a pulse at the set time interval.
Dead band	1	Adds dead band compensation to the input and outputs the result.
Pulse No. counter	1	Detects rise of pulse and counts the number of pulses.
Pulse No. output	1	Integrates the input signal and converts it to number of pulses for output.
Decoder	1	Decodes 2-bit pure binary input and outputs it to 4 terminals.
Running average	2	Calculates running average of input data and outputs the result.
Sample & hold	1	Holds the input value according to sample signal(0/1) and continues the output.
Dead time	6	Usable for dead time compensation control etc. Data sampling can be done in 1 sec or 1 min units.
ON-OFF	1	Outputs ON-OFF signal with hysteresis.
Alarm	1	Compares the input and set value and outputs the judgment result.
Pulse width modulator	1	Performs output processing in time proportional PID control.
Indicator	8	Indicate input data on the front display (using 3 bar-graph display)

A variety of applications are possible through combination of WAFERS.

## Table 2

List of Thermocouple and Resistance Bulb Measurable range

	Input signal	Input type code	Input range code	Measurable range°C
Thermocouple	J	01	00	0.0~400.0
	J		01	0.0~800.0
	K		02	0.0~400.0
	K		03	0.0~800.0
	K		04	0.0~1200.0
	R		05	0.0~1600.0
	B		06	0.0~1800.0
	T		07	-200.0~200.0
	T		08	-150.0~400.0
	E		09	0.0~800.0
	E		10	-200.0~800.0
	S		11	0.0~1600.0
	N		12	0.0~1300.0
	U		13	-200.0~400.0
	WRe5-26		14	0.0~2300.0
PL II	15	0.0~1300.0		
Resistance bulb	Pt100	00	00	0.0~150.0
			01	0.0~300.0
			02	0.0~500.0
			03	0.0~600.0
			04	-50.0~100.0
			05	-100.0~200.0
			06	-200.0~600.0
			07	-200.0~850.0
Resistance bulb	JPt100	00	08	0.0~150.0
			09	0.0~300.0
			10	0.0~500.0
			11	0.0~600.0
			12	-50.0~100.0
			13	-100.0~200.0
			14	-200.0~600.0

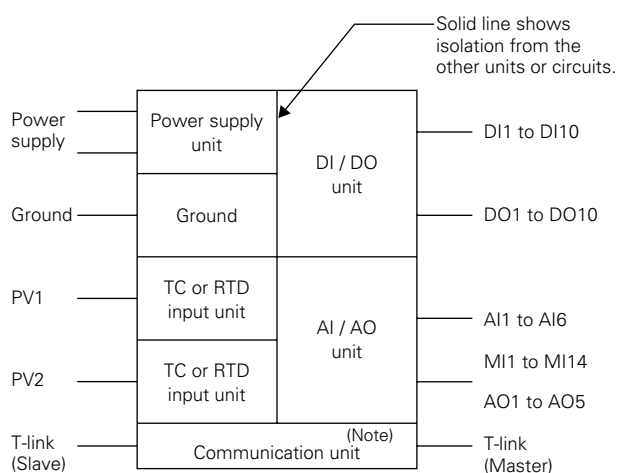
## SCOPE OF DELIVERY

Controller, panel mounting bracket, instruction manual (depend on code symbols)

## Optional Items

Item	Type	Specification	Available unit
Terminator for communication (100 Ω)	PDZR1001	For screw terminal	1
	PDZR2001	For compression terminal	1
34-pin multiple connector (Note1)	PDZC1001	Solder type straight terminal	1
	PDZC2001	Solder type right angle terminal	1
	PDZC3001	Solderless type straight terminal	1
	PDZC4001	Solderless type right angle terminal	1
Shunt resistor (250 Ω)	PDZS1001	For screw terminal	1
	PDZS2001	For compression terminal	1
Communication cable for configuration software	PDZL1001	Commonly usable cable for configuration software (3m length)	1
Communication cable (Note2)			
For screw terminal, from PDA to PDA	PDZK1xx1	M3.5 solderless terminals at both ends	1
For screw terminal, from PDA to PLC	PDZK2xx1	M3.5 solderless terminals at both ends	1
For screw terminal, from PDA to PC	PDZK3xx1	9-pin connector at PC side end	1
For compression terminal, from PDA to PDA	PDZK4xx1	With compression terminal at both ends	1
For compression terminal, from PDA to PLC	PDZK5xx1	With M3.5 solderless terminal on PLC side	1
For compression terminal, from PDA to PC	PDZK6xx1	9-pin connector on PC side	1
Replacing case	PDZE1002	For replacing CC-F	1
Compact Controller M (CC-M) Instruction Manual in book form (in Japanese)	PDZX1001	Instruction manual in book form	1
Compact Controller M (CC-M) Instruction Manual in book form (in English)	PDZX2001	Instruction manual in book form	1
Compact Controller M (CC-M) Introductory Guide in book form (in Japanese)	PDZX3001	Instruction manual in book form	1
Compact Controller M (CC-M) Introductory Guide in book form (in English)	PDZX4001	Instruction manual in book form	1
Instruction Manual on CD-ROM (in Japanese and English) (Note3)	PDZQ1001	Instruction manual on CD-ROM	1
Mounting bracket (Note4)	PDZA1001	Improved mounting bracket	1

## Block diagram of electrical isolation



(Note) The communication unit is not isolated from the AI/AO unit when using T-link.

(Note 1) This connector is required for using the controll output 3 and 4 or digital input / output with the screw terminal type.

(Note 2) These cables are used for T-link and Modbus®. Length needs to be specified.

(Note 3) The instruction manual and introductory guide both in Japanese and English, and programming loader software (in Japanese) are included.

(Note 4) This is the improved mounting bracket adopted from PDA-2. Refer to the outline diagram for shape and dimensions.

# CODE SYMBOLS

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15															
PDA- - - - - - - - - - - - - - -															
Description															
2		Controller function <4th digit code>													
2		Programmable type													Note 1
1		Number of control loops <5th digit code>													Note 2
2		1 loop (1 control output)													
2		2 loops (2 control outputs)													
4		4 loops (4 control outputs)													
1		External terminal <6th digit code>													
2		M3.5 screw terminal													
2		Compression terminal													
A		Input signal <7th digit code>													
C		1 to 5 V DC													Note 3
D		Thermocouple													Note 4
D		Resistance bulb Pt100													Note 4
E		Resistance bulb JPt100													Note 4
A		Power supply voltage <9th digit code>													
B		100V to 240V AC (Usable range 85V to 264V AC) 50 / 60Hz													
B		24V DC (Usable range 20 to 30V DC)													
C		Operation mode <10th digit code>													
A		Cascade-Auto-Manual changeable type													
R		Auto-Manual changeable type													
R		Remote-Auto-Manual changeable type													
Y		Backup operation unit <11th digit code>													
A		Without													
B		For 1 control output, 100 to 240 V AC													
C		For 2 control outputs, 100 to 240 V AC													
D		For 4 control outputs, 100 to 240 V AC													
E		For 1 control output, 24 V DC													
E		For 2 control outputs, 24 V DC													
F		For 4 control outputs, 24 V DC													
Y		Communication / Memory card interface <12th digit code>													
M		(Slave) (Master) (memory card interface) Note5 Note6													
A		Without Without Without													
B		Without Without With													
A		T-link Without Without													
B		T-link T-link Without													
S		T-link Without With													
T		T-link T-link With													
Y		Instruction manual <13th digit code>													
C		Without													
C		Instruction manual on CD-ROM (in Japanese and English) Note 9													
1		Programming method <14th digit code>													
1		WAFER connection method													
0		Factory configuration <15th digit code>													
8		Without WAFER connection													Note 7
8		With up to 48 WAFER connection													Note 8
9		With more than 49 WAFER connection													Note 8

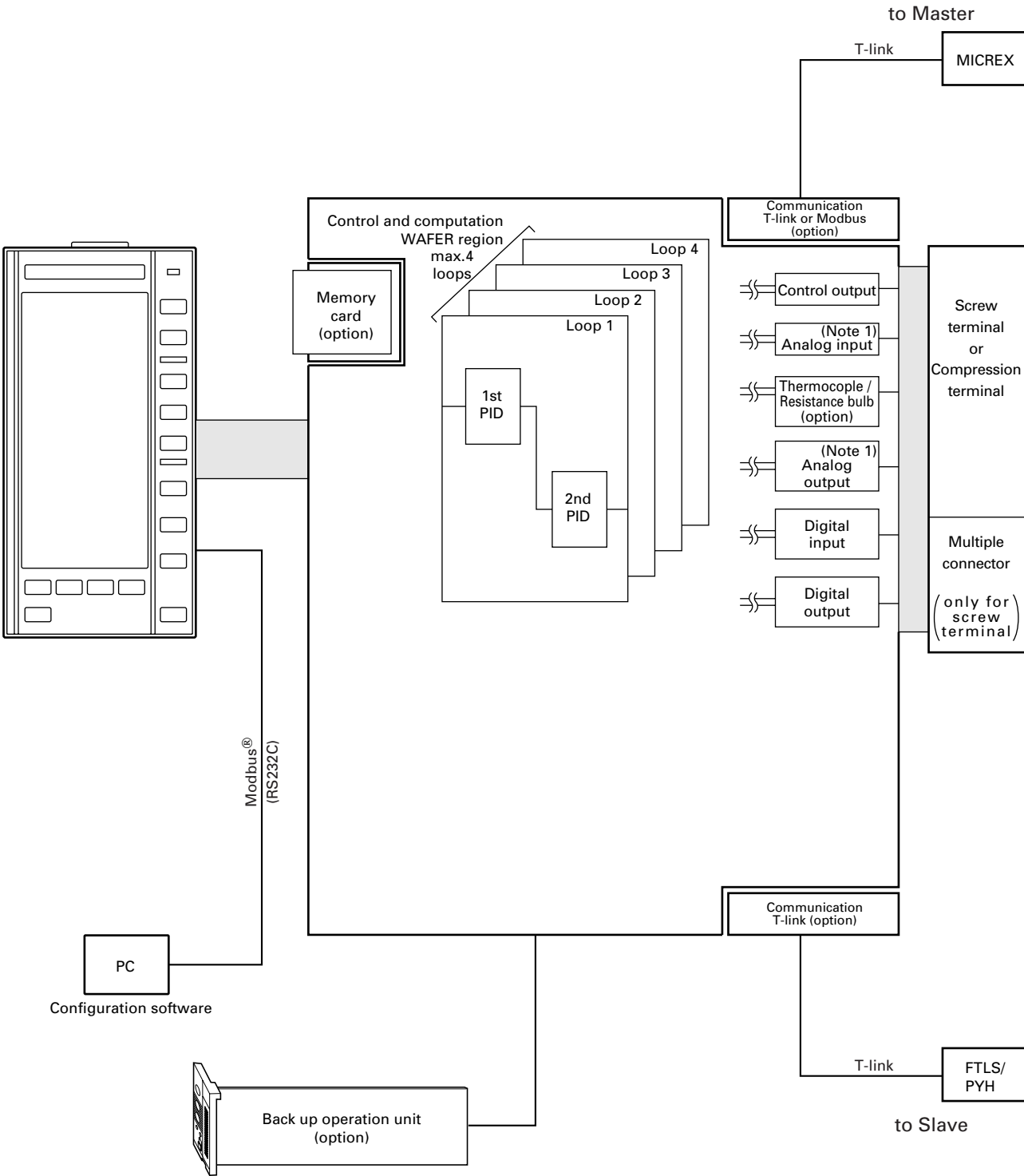
- Note 1) Control and computation function could be done by WAFER connection.
- Note 2) Control loop means the number of control output.
- Note 3) For current input, a shunt resistor is used for conversion into voltage. Shunt resistor is optional item.
- Note 4) Thermocouple and resistance bulb input are optional items. Allowable up to 2 points. The remaining input will be 1 to 5 V DC.
- Note 5) Communication cable and terminator are optional items.
- Note 6) Recommended maker: Sandisk corporation.
- Note 7) In this case, WAFER connection programming should be made by user. Connection tool (Programming loader) is optional item.
- Note 8) WAFER connection specification sheets need to be prepared and submitted by user to Fuji.

Input signal and measurable range initial set before delivery is as follows.  
 For specification of voltage input, scale is 0.00 to 100.00%  
 For specification of thermocouple, K, 0.0 to 400.0°C.  
 For specification of resistance bulb, Pt and JPt are 0.0 to 150.0°C.

- Note 9) This CD-ROM contains the programming loader written in Japanese. However, the communication cable (PDZL1001) is separately available. The relevant manual is stored in the PDF file format. For reading the manual, Adobe® Acrobat® Reader is required. The CD-ROM also contains the Acrobat® Reader setup program.



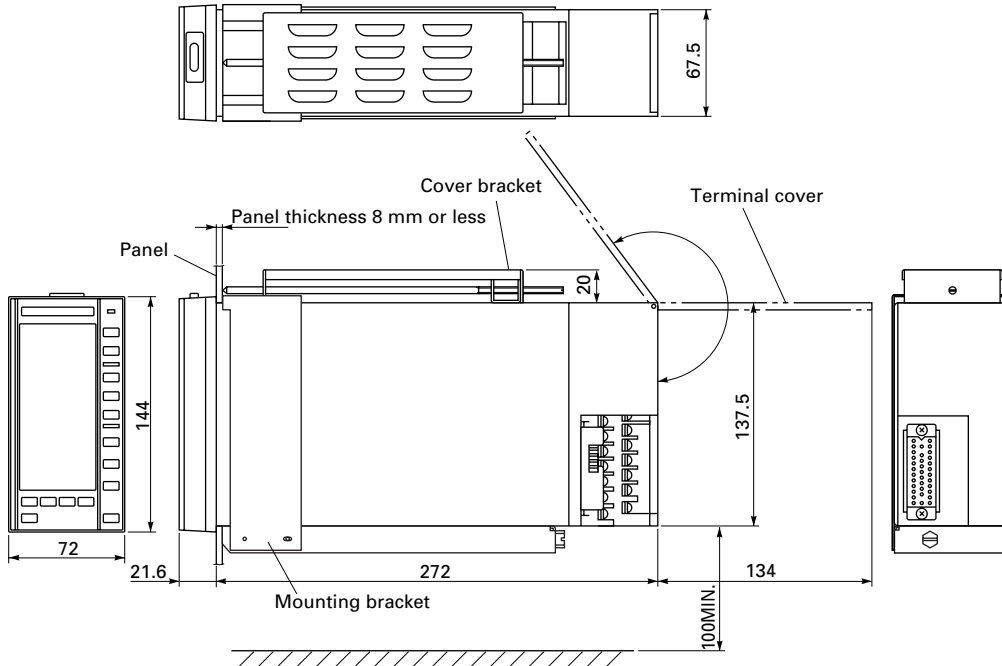
# FUNCTIONAL DIAGRAM



(Note 1) The numbers of analog input and auxiliary analog output differ depending on external terminals.

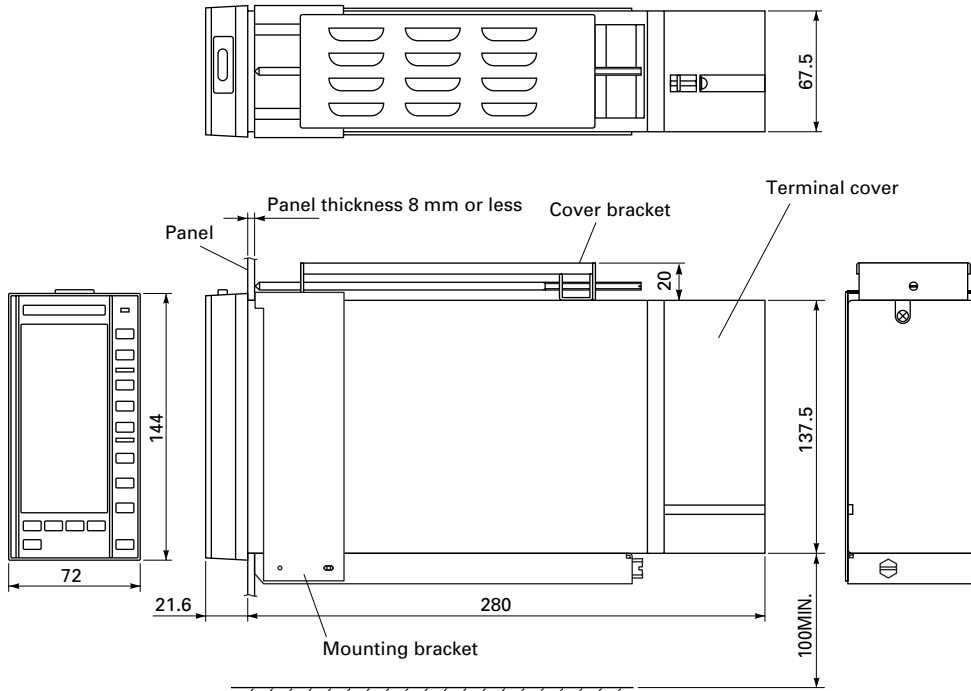
# OUTLINE DIAGRAM (Unit : mm)

## SCREW TERMINAL TYPE



Note) The distance between other instruments and low end of PDA shall be more than 100mm.

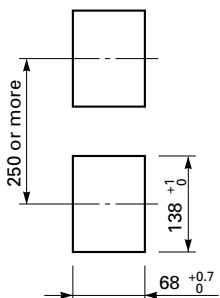
## COMPRESSION TERMINAL TYPE



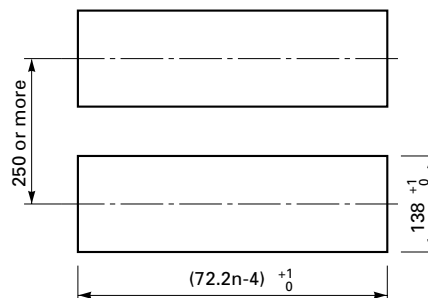
Note) The distance between other instruments and low end of PDA shall be more than 100mm.

## PANEL CUTOUT DIMENSIONS

For mounting one unit

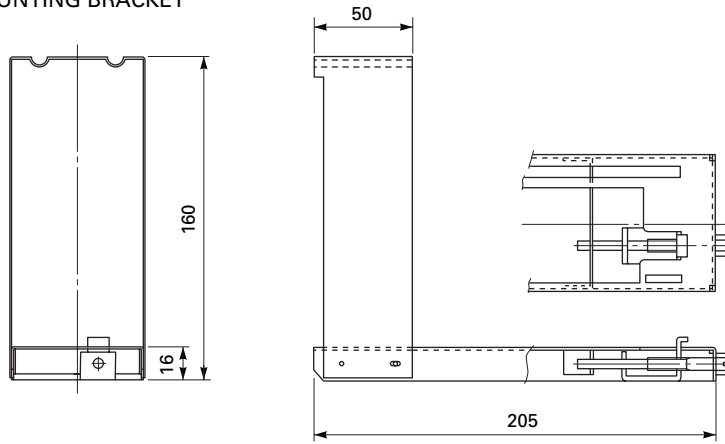


For mounting multiple "n" units



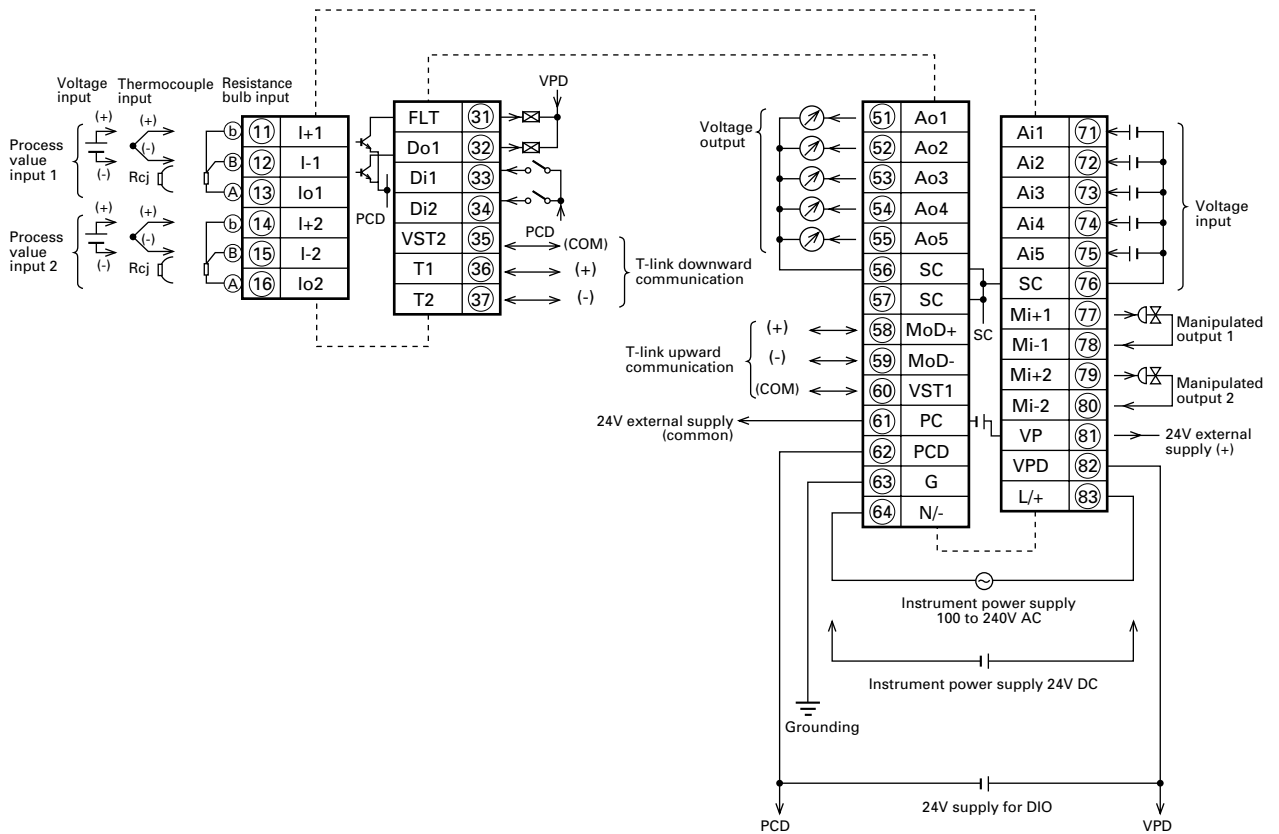
Number of  
 $n \geq 2$   
 $n$ ; Q'TY

**MOUNTING BRACKET**



**EXTERNAL CONNECTION DIAGRAM**

**SCREW TERMINAL TYPE . . . . M3.5 screw terminal section**



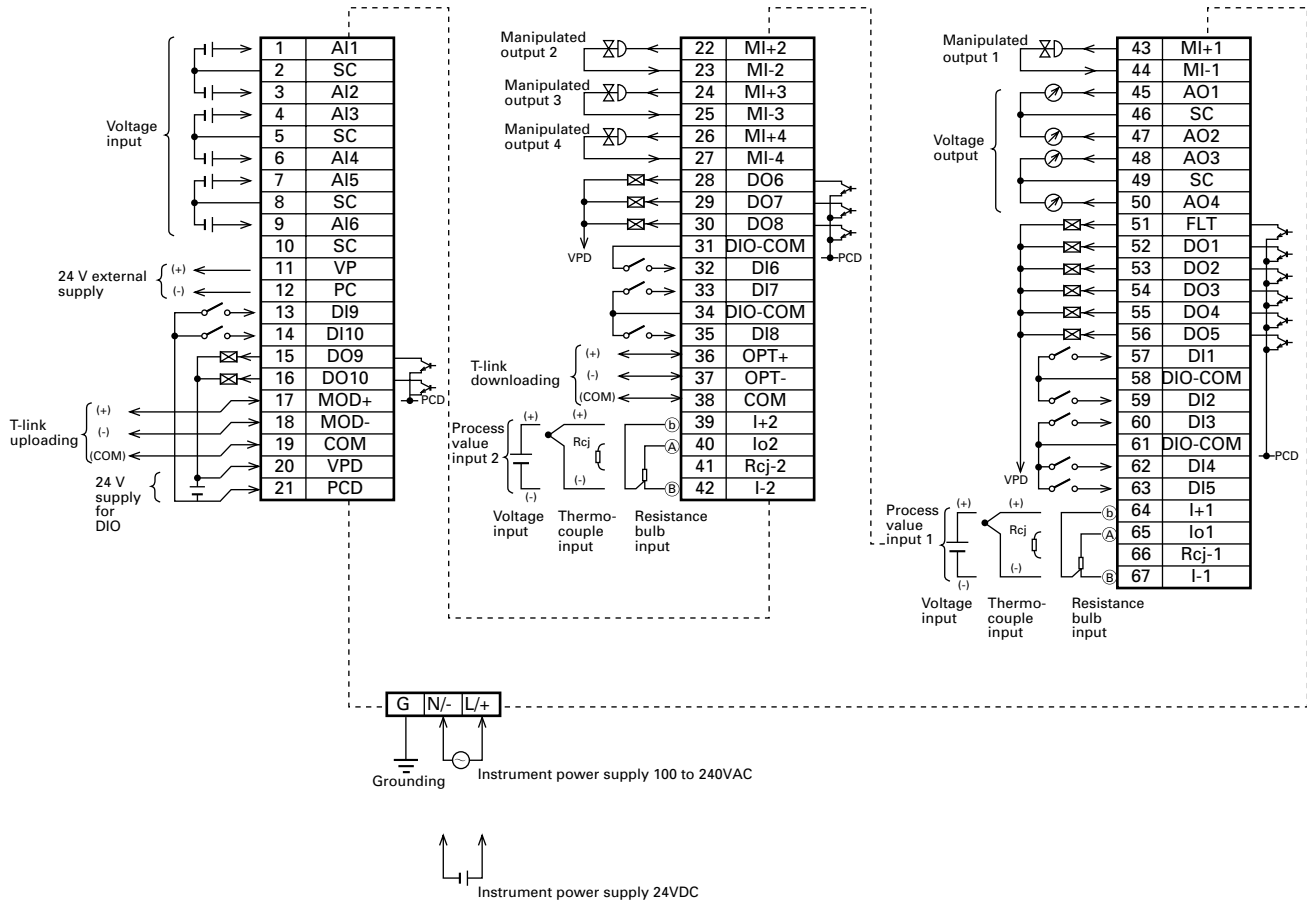
**SCREW TERMINAL TYPE . . . . Multipul terminal section**

Multipul connector

23	Do1		1	Mi+3
24	Do2	13	2	Mi-3
25	Do3	14	3	Mi+4
26	Do4	15	4	Mi-4
27	Do5	16	5	Ao1
28	Do6	17	6	Ao2
29	Do7	18	7	Ai1
30	Do8	19	8	Ai2
31	Do9	20	9	Ai3
32	Do10	21	10	Ai4
33	VPD	22	11	SC
34	PCD		12	PCD

# EXTERNAL CONNECTION DIAGRAM

## COMPRESSION TERMINAL TYPE



[Note] Windows® is the registered trade mark of Microsoft corporation.  
 [Note] Modbus® is the registered trade mark of Gould Modicon.  
 [Note] Compact Flash® is the registered trade mark of Sandisk corporation.  
 [Note] Pentium® is the registered trade mark of Intel corporation.  
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⚠ Caution on Safety  
 \*Before using this product, be sure to read its instruction manual in advance.

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